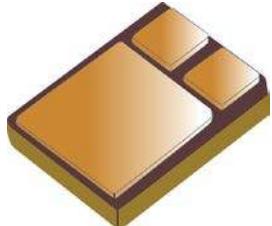


**RADIATION HARDENED  
NPN POWER SILICON TRANSISTOR**  
*Qualified per MIL-PRF-19500/544*

**Qualified Levels:**  
 JANSM, JANSD,  
 JANSP, JANSL,  
 JANSR, JANSF

**DESCRIPTION**

These RHA level 2N5152U3 and 2N5154U3 silicon transistor devices are military Radiation Hardness Assurance qualified up to a JANSF level for high-reliability applications. Microsemi also offers numerous other products to meet higher and lower power voltage regulation applications.



**Important:** For the latest information, visit our website <http://www.microsemi.com>.

**FEATURES**

- JEDEC registered 2N5152 and 2N5154.
- JANS RHA qualifications are available per MIL-PRF-19500/544.

**U3 (SMD-0.5)  
Package**

**Also available in:**

 **TO-5 Package**  
(long-leaded)  
 JANS\_2N5152L &  
 JANS\_2N5154L

 **TO-39 Package**  
(leaded)  
 JANS\_2N5152 &  
 JANS\_2N5154

**APPLICATIONS / BENEFITS**

- High frequency operation.
- Lightweight.
- High-speed power-switching applications.
- High-reliability applications.

**MAXIMUM RATINGS**

Parameters/Test Conditions	Symbol	Value	Unit
Junction and Storage Temperature	T <sub>J</sub> and T <sub>STG</sub>	-65 to +200	°C
Thermal Resistance Junction-to-Ambient	R <sub>θJA</sub>	175	°C/W
Thermal Resistance Junction-to-Case	R <sub>θJC</sub>	10	°C/W
Reverse Pulse Energy <sup>(1)</sup>		15	mJ
Collector Current (dc)	I <sub>C</sub>	2	A
Collector to base voltage (static), emitter open	V <sub>CBO</sub>	100	V
Collector to emitter voltage (static) base open	V <sub>CEO</sub>	80	V
Emitter to base voltage (static) collector open	V <sub>EBO</sub>	5.5	V
Steady-State Power Dissipation @ T <sub>A</sub> = +25 °C	P <sub>D</sub>	1	W
Steady-State Power Dissipation @ T <sub>C</sub> = +25 °C	P <sub>D</sub>	10	W

**Notes:** 1. This rating is based on the capability of the transistors to operate safely in the unclamped inductive load energy test circuit.

**MSC – Lawrence**

6 Lake Street,  
 Lawrence, MA 01841  
 Tel: 1-800-446-1158 or  
 (978) 620-2600  
 Fax: (978) 689-0803

**MSC – Ireland**

Gort Road Business Park,  
 Ennis, Co. Clare, Ireland  
 Tel: +353 (0) 65 6840044  
 Fax: +353 (0) 65 6822298

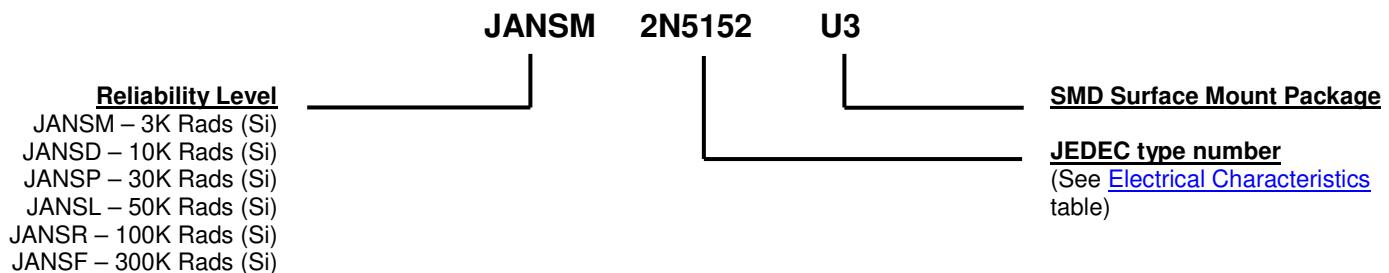
**Website:**

[www.microsemi.com](http://www.microsemi.com)

### MECHANICAL and PACKAGING

- CASE: Ceramic and gold over nickel plated steel.
- TERMINALS: Gold over nickel plated tungsten/copper.
- MARKING: Part number, date code, A = anode.
- POLARITY: See [schematic](#) on last page.
- WEIGHT: 0.9 grams.
- See [Package Dimensions](#) on last page.

### PART NOMENCLATURE



### SYMBOLS & DEFINITIONS

Symbol	Definition
$C_{obo}$	Common-base open-circuit output capacitance.
$I_{CEO}$	Collector cutoff current, base open.
$I_{CEX}$	Collector cutoff current, circuit between base and emitter.
$I_{EBO}$	Emitter cutoff current, collector open.
$h_{FE}$	Common-emitter static forward current transfer ratio.
$V_{CEO}$	Collector-emitter voltage, base open.
$V_{CBO}$	Collector-emitter voltage, emitter open.
$V_{EBO}$	Emitter-base voltage, collector open.

**ELECTRICAL CHARACTERISTICS @  $T_A = +25^\circ\text{C}$  unless otherwise noted.**
**OFF CHARACTERISTICS**

<b>Parameters / Test Conditions</b>	<b>Symbol</b>	<b>Min.</b>	<b>Max.</b>	<b>Unit</b>
Collector-Emitter Breakdown Voltage $I_C = 100 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	80		V
Emitter-Base Cutoff Current $V_{EB} = 4.0 \text{ V}, I_C = 0$ $V_{EB} = 5.5 \text{ V}, I_C = 0$	$I_{EBO}$		1.0 1.0	$\mu\text{A}$ mA
Collector-Emitter Cutoff Current $V_{CE} = 60 \text{ V}, V_{BE} = 0$ $V_{CE} = 100 \text{ V}, V_{BE} = 0$	$I_{CES}$		1.0 1.0	$\mu\text{A}$ mA
Collector-Emitter Cutoff Current $V_{CE} = 40 \text{ V}, I_B = 0$	$I_{CEO}$		50	$\mu\text{A}$

**ON CHARACTERISTICS**

<b>Parameters / Test Conditions</b>	<b>Symbol</b>	<b>Min.</b>	<b>Max.</b>	<b>Unit</b>
Forward-Current Transfer Ratio $I_C = 50 \text{ mA}, V_{CE} = 5 \text{ V}$	$h_{FE}$	20	--	
2N5152U3		50	--	
2N5154U3		30	90	
2N5152U3		70	200	
$I_C = 2.5 \text{ A}, V_{CE} = 5 \text{ V}$	$h_{FE}$	20	--	
2N5154U3		40	--	
2N5152U3		20	--	
2N5154U3		40	--	
Collector-Emitter Saturation Voltage $I_C = 2.5 \text{ A}, I_B = 250 \text{ mA}$ $I_C = 5.0 \text{ A}, I_B = 500 \text{ mA}$	$V_{CE(\text{sat})}$		0.75 1.5	V
Base-Emitter Voltage Non-Saturation $I_C = 2.5 \text{ A}, V_{CE} = 5 \text{ V}$	$V_{BE}$		1.45	V
Base-Emitter Saturation Voltage $I_C = 2.5 \text{ A}, I_B = 250 \text{ mA}$ $I_C = 5.0 \text{ A}, I_B = 500 \text{ mA}$	$V_{BE(\text{sat})}$		1.45 2.2	V

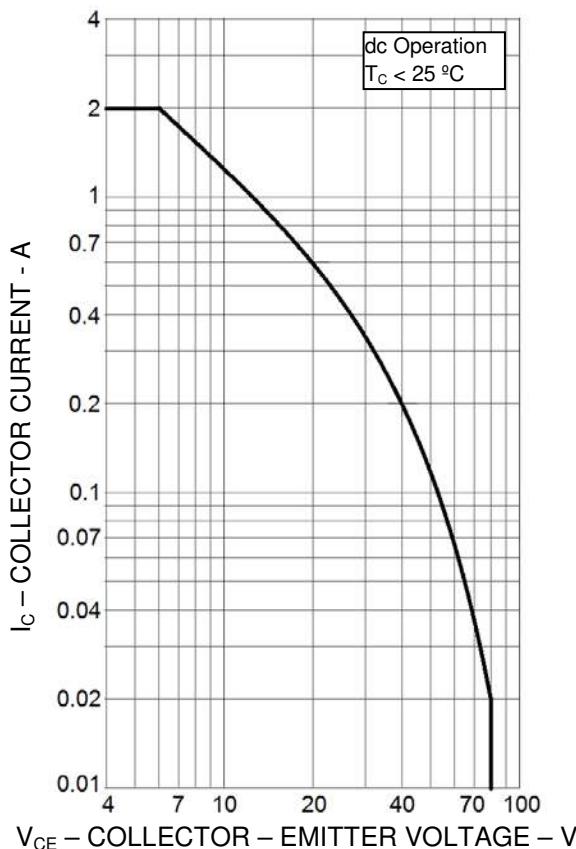
**DYNAMIC CHARACTERISTICS**

<b>Parameters / Test Conditions</b>	<b>Symbol</b>	<b>Min.</b>	<b>Max.</b>	<b>Unit</b>
Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 500 \text{ mA}, V_{CE} = 5 \text{ V}, f = 10 \text{ MHz}$	$ h_{fe} $	6 7		
2N5152U3				
2N5154U3				
Small-signal short Circuit Forward-Current Transfer Ratio $I_C = 100 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ KHz}$	$h_{fe}$	20 50		
2N5152U3				
2N5154U3				
Output Capacitance $V_{CB} = 10 \text{ V}, I_E = 0, f = 1.0 \text{ MHz}$	$C_{obo}$		250	pF

**ELECTRICAL CHARACTERISTICS @  $T_A = +25^\circ\text{C}$  unless otherwise noted. (continued)**
**SWITCHING CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Turn-On Time $I_C = 5 \text{ A}, I_{B1} = 500 \text{ mA}$	$t_{on}$		0.5	$\mu\text{s}$
Turn-Off Time $R_L = 6\Omega$	$t_{off}$		1.5	$\mu\text{s}$
Storage Time $I_{B2} = -500 \text{ mA}$	$t_s$		1.4	$\mu\text{s}$
Fall Time $V_{BE(OFF)} = 3.7 \text{ V}$	$t_f$		0.5	$\mu\text{s}$

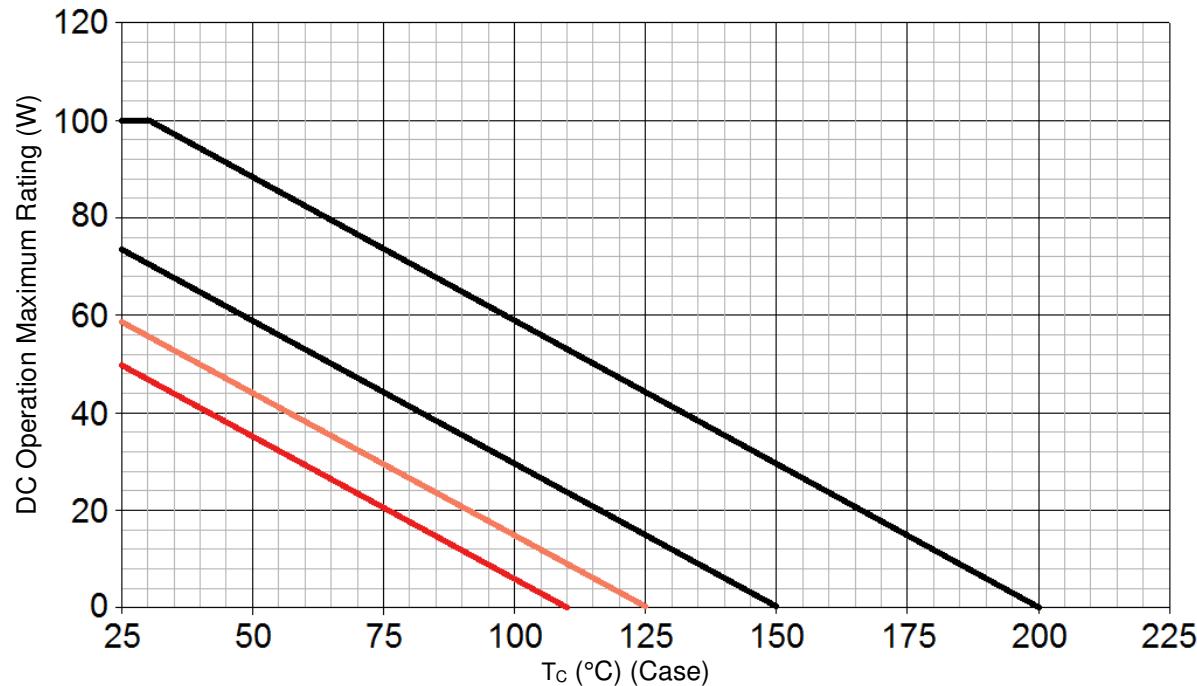
**SAFE OPERATING AREA** (See SOA graph below and [MIL-STD-750, method 3053](#))

**DC Tests**
 $T_c = +25^\circ\text{C}, t_p = 1.0 \text{ s, 1 Cycle}$ 
**Test 1**
 $V_{CE} = 5.0 \text{ V}, I_C = 2.0 \text{ A}$ 
**Test 2**
 $V_{CE} = 32 \text{ V}, I_C = 310 \text{ mA}$ 
**Test 3**
 $V_{CE} = 80 \text{ V}, I_C = 12.5 \text{ mA}$ 

Maximum Safe Operating Area

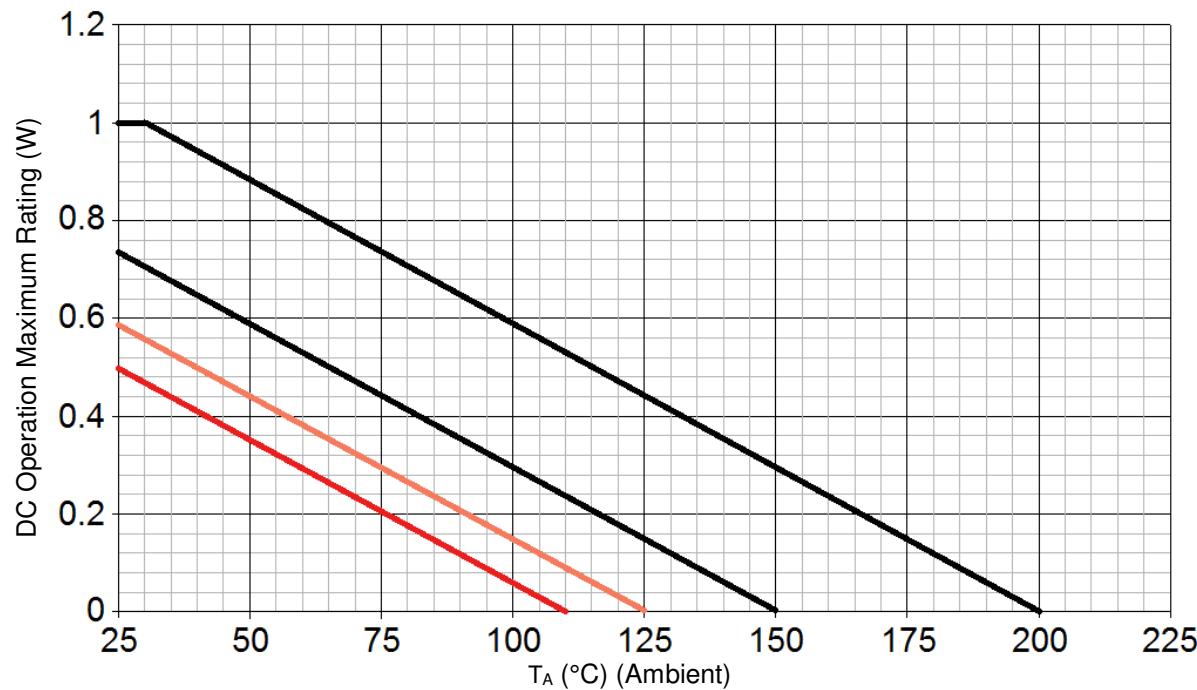
**ELECTRICAL CHARACTERISTICS @  $T_A = +25^\circ\text{C}$ , unless otherwise noted (continued)**
**POST RADIATION ELECTRICAL CHARACTERISTICS**

<b>Parameters / Test Conditions</b>	<b>Symbol</b>	<b>Min.</b>	<b>Max.</b>	<b>Unit</b>
Collector to Emitter Cutoff Current $V_{CE} = 40 \text{ V}$	$I_{CEO}$		100	$\mu\text{A}$
Emitter to Base Cutoff Current $V_{EB} = 4 \text{ V}$	$I_{EBO}$		2.0	$\mu\text{A}$
Breakdown Voltage, Collector to Emitter $I_C = 100 \text{ mA}$	$V_{(BR)CEO}$	80		V
Collector to Emitter Cutoff Current $V_{CE} = 60 \text{ V}$	$I_{CES}$		2.0	$\mu\text{A}$
Emitter to Base Cutoff Current $V_{EB} = 5.5 \text{ V}$	$I_{EBO}$		2.0	mA
Forward-Current Transfer Ratio <sup>(1)</sup> $I_C = 50 \text{ mA}, V_{CE} = 5 \text{ V}$	2N5152U3	[10]		
	2N5154U3	[25]		
$I_C = 2.5 \text{ A}, V_{CE} = 5 \text{ V}$	2N5152U3	[15]	90	
	2N5154U3	[35]	200	
$I_C = 5 \text{ A pulsed}, V_{CE} = 5 \text{ V}$	2N5152U3	[10]		
	2N5154U3	[20]		
Base to Emitter voltage (non-saturated) $V_{CE} = 5 \text{ V}, I_C = 2.5 \text{ A, pulsed}$	$V_{BE}$		1.45	V
Collector-Emitter Saturation Voltage $I_C = 2.5 \text{ mA}, I_B = 250 \text{ mA, pulsed}$ $I_C = 500 \text{ mA}, I_B = 500 \text{ mA, pulsed}$	$V_{CE(sat)}$		0.86 1.73	V
Base-Emitter Saturation Voltage $I_C = 2.5 \text{ A}, I_B = 250 \text{ mA, pulsed}$ $I_C = 5 \text{ A}, I_B = 500 \text{ mA, pulsed}$	$V_{BE(sat)}$		1.67 2.53	V

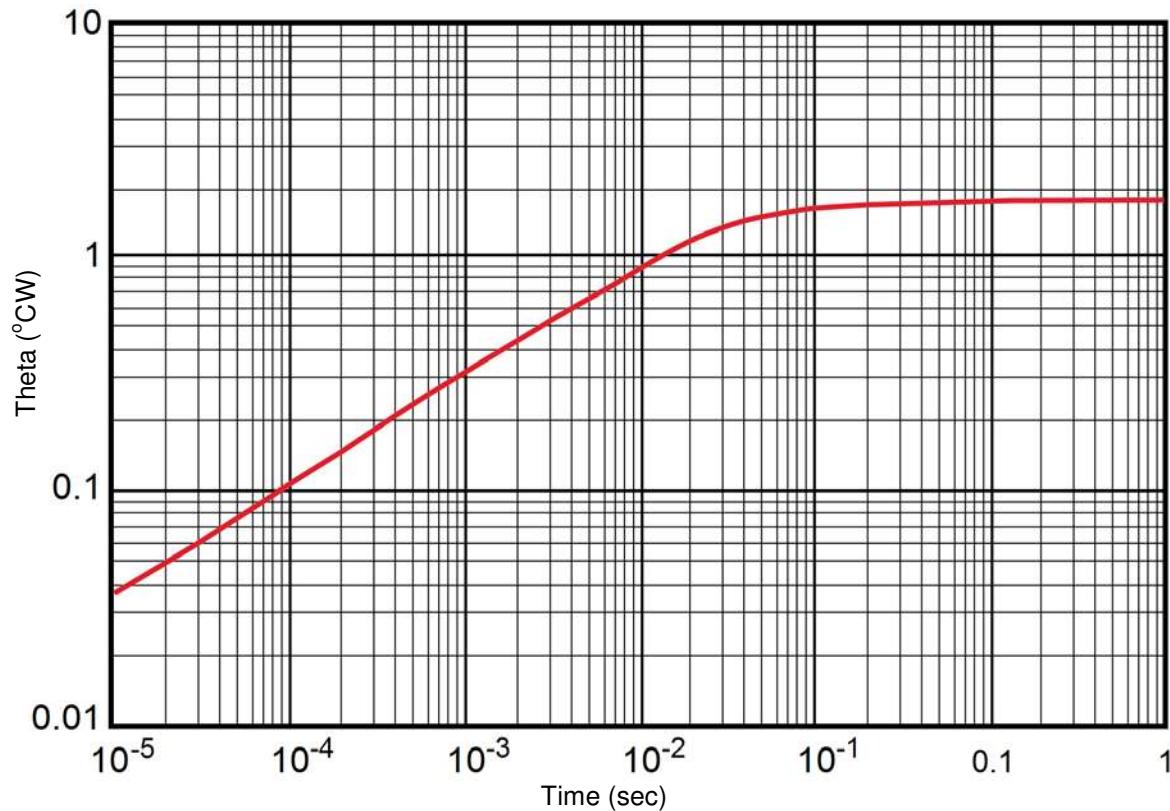
- (1) See method 1019 of MIL-STD-750 for how to determine  $[h_{FE}]$  by first calculating the delta ( $1/h_{FE}$ ) from the pre- and post-radiation  $h_{FE}$ . Notice the  $[h_{FE}]$  is not the same as  $h_{FE}$  and cannot be measured directly. The  $[h_{FE}]$  value can never exceed the pre-radiation minimum  $h_{FE}$  that it is based upon.

**GRAPHS**

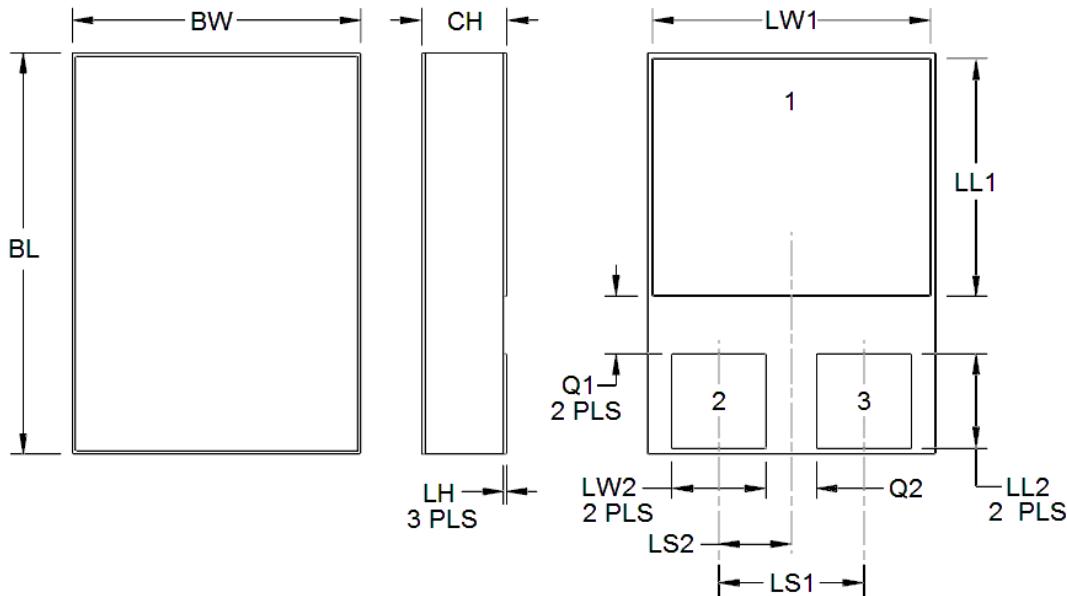
**FIGURE 1**  
Temperature-Power Derating Curve



**FIGURE 2**  
Temperature-Power Derating Curve

**GRAPHS (continued)**

**FIGURE 3**  
Maximum Thermal Impedance ( $R_{eJC}$ )

**PACKAGE DIMENSIONS**

**NOTES:**

1. Dimensions are in inches.
2. Millimeters are given for general information only.
3. In accordance with ASME Y14.5M, diameters are equivalent to  $\Phi x$  symbology.


**Schematic**

Symbol	DIMENSIONS			
	INCH		MILLIMETERS	
	Min	Max	Min	Max
BL	.395	.405	10.03	10.29
BW	.291	.301	7.39	7.65
CH	.112	.124	2.84	3.15
LH	.010	.020	0.25	0.51
LL1	.220	.230	5.59	5.84
LL2	.115	.125	2.92	3.18
LS1	.150 BSC		3.81 BSC	
LS2	.075 BSC		1.91 BSC	
LW1	.281	.291	7.14	7.39
LW2	.090	.100	2.29	2.54
Q1	.030		0.76	
Q2	.030		0.76	
Term 1	Cathode			
Term 2	Anode (See Schematic)			
Term 3	Anode (See Schematic)			